ASSEMBLY JIG AND MANUFACTURING METHOD OF MULTILAYER SEMICONDUCTOR DEVICE
REPLACEMENT DRAWINGS
Inventor: Yoshiyuki Yanagisawa et al.
Serial No. 09/876,290
Robert J. Depke, Holland & Knight LLP - (312) 263-3600

FIG.2(a)

FIG.2(b)

FIG.2(c)

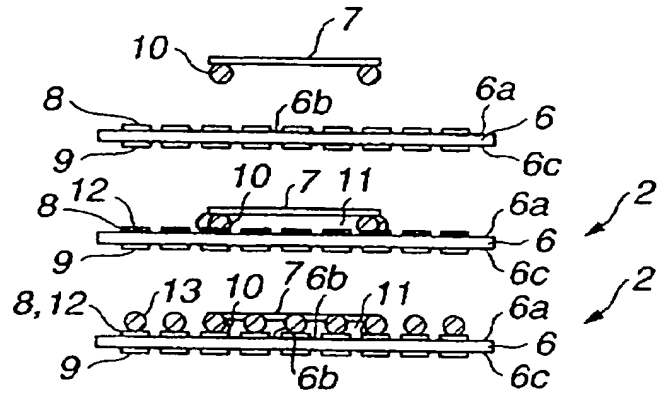


FIG.2(d)

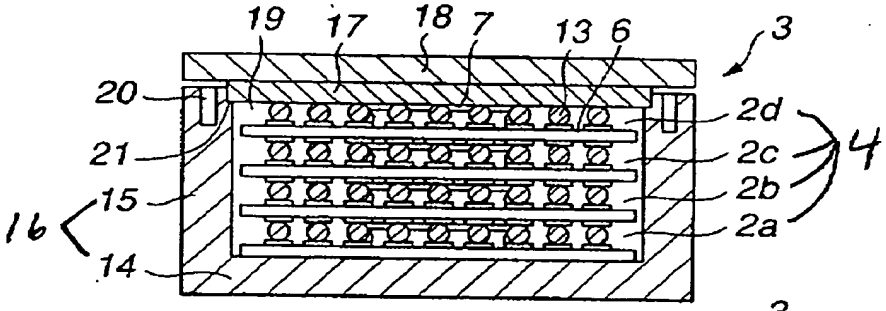


FIG.2(e)

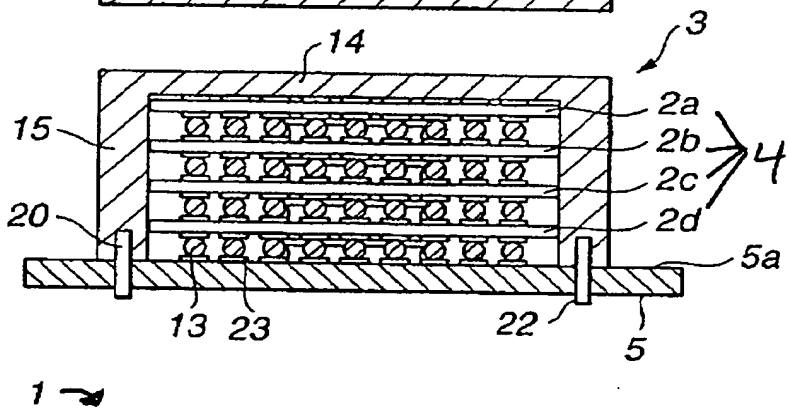
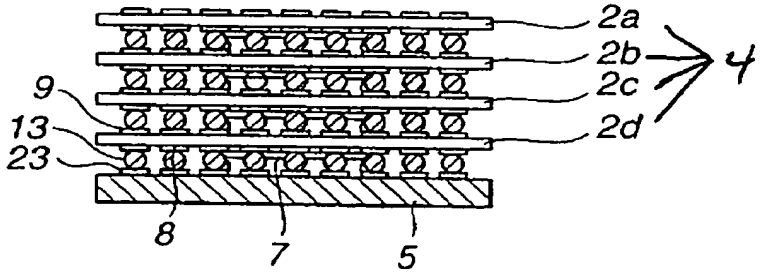
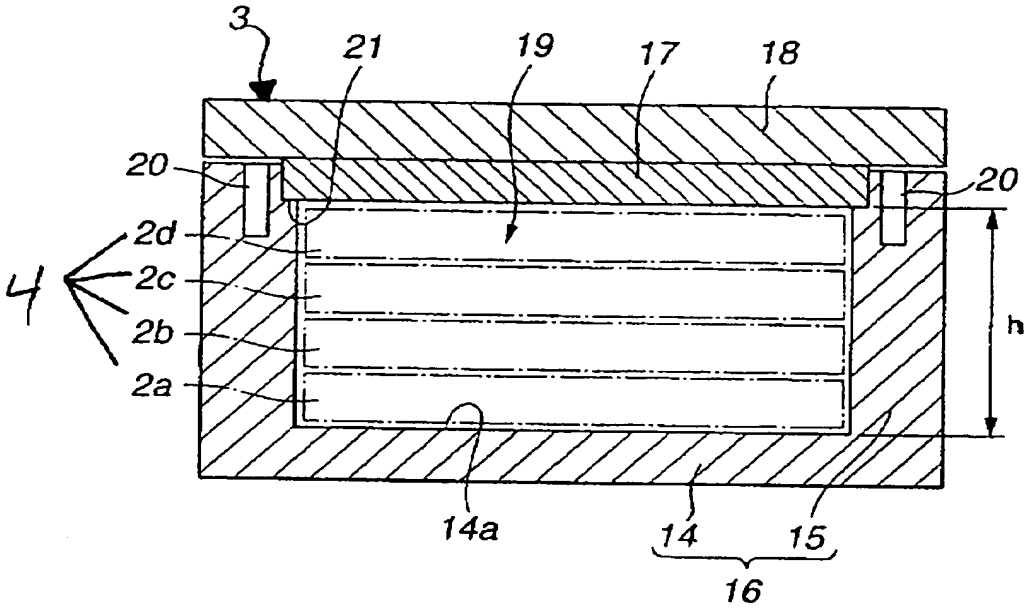


FIG.2 (f)




3
21
19
17
18
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2d
2c
2b
2a
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h
14a
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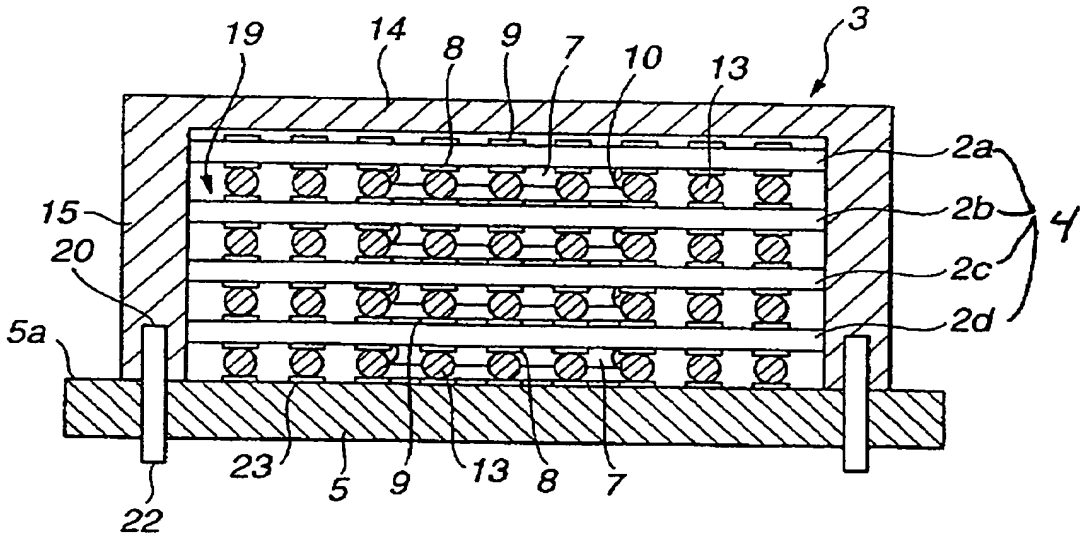
FIG.3


19
14
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13
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2a
2b
2c
2d
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15
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5a
23
5
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13
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7
22

FIG.4

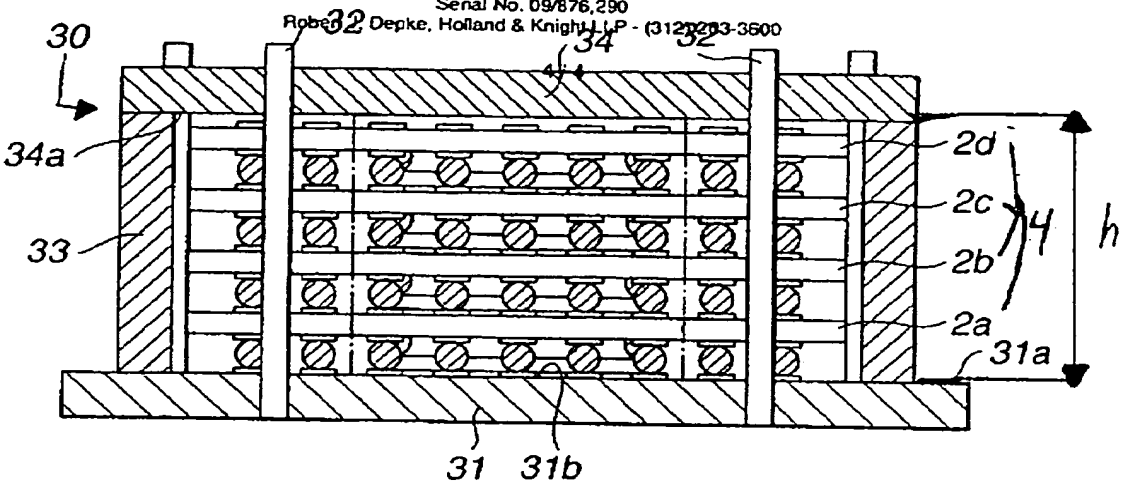

FIG.5(a)

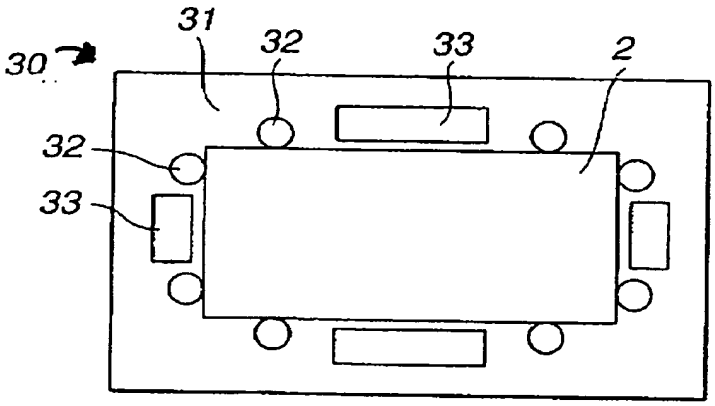

FIG.5(b)

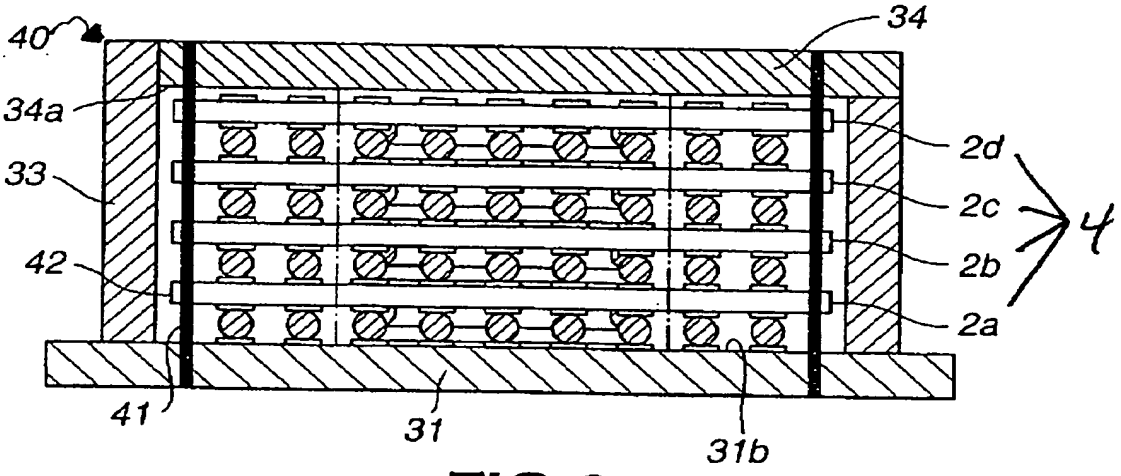

FIG.6